05/13/2014 502806547

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT2853141

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
BENJAMIN MICHAEL SUTTON	05/06/2014
SREENIVASAN K KODURI	05/08/2014
SUBHASHISH MUKHERJEE	05/12/2014

RECEIVING PARTY DATA

Name:	TEXAS INSTRUMENTS INCORPORATED
Street Address:	12500 TI BOULEVARD
Internal Address:	MS 3999
City:	DALLAS
State/Country:	TEXAS
Postal Code:	75243

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14275762

CORRESPONDENCE DATA

(214)479-1273 Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via

US Mail.

Phone: 7139378823

Email: gerald@lawspatents.com

Correspondent Name: TEXAS INSTRUMENTS INCORPORATED

Address Line 1: PO BOX 655474

Address Line 2: MS 3999

Address Line 4: DALLAS, TEXAS 75265

ATTORNEY DOCKET NUMBER:	TI-74206
NAME OF SUBMITTER:	GERALD E LAWS
SIGNATURE:	/Gerald E Laws 39268/
DATE SIGNED:	05/13/2014

Total Attachments: 3

source=TI-74206-ASG#page1.tif source=TI-74206-ASG#page2.tif

> **PATENT** REEL: 032878 FRAME: 0956 502806547

source=TI-74206-ASG#page3.tif

PATENT REEL: 032878 FRAME: 0957

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made.

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 12500 TI Boulevard - M/S 3999, Dallas, Texas 75243, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign unto the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in and to the said application(s) and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Patent and Trademark Office to issue all patents for said invention, or patents resulting therefrom, to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, title and interest.

I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my corresponding rights to the invention disclosed in said application in all other countries of the world, including the right to claim priority, file applications and obtain patents under the terms of the Paris Convention for the Protection of Industrial Property, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

I authorize the later insertion of the nonprovisional application number and filing date herein below.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE	A Cantilevered Leadframe Integrated Circuit Dies	Support Structure for Magnetic	: Wireless Transfer Between
NONPROVISIONAL APPLICATION NO.	14/275,762	FILING DATE	May 12, 2014
		0.00	
SIGNATURE OF INVENTOR	KenSulfo	<i>1</i>	
PRINTED NAME OF INVENTOR	Benjamin Michael Sutton		
DATE	5/6/14		
RESIDENCE (CITY, STATE and COUNTRY)	Dallas, TX, USA		

PATENT REEL: 032878 FRAME: 0958

SIGNATURE OF INVENTOR	Sverivan Kodi
PRINTED NAME OF INVENTOR	Sreenivasan K Koduri
DATE	May-8-2014
RESIDENCE (CITY, STATE and COUNTRY)	Allen, TX, USA
SIGNATURE OF INVENTOR	
PRINTED NAME OF INVENTOR	Subhashish Mukherjee
DATE	
RESIDENCE (CITY, STATE and COUNTRY)	Doddanckundi, Bangalore, India

After recording, return Assignment to:

Texas instruments incorporated PO Box 655474, M/S 3999 Dallas, TX 75265

SIGNATURE OF INVENTOR	
PRINTED NAME OF INVENTOR	Samuel Karana Karana (1996) and a substitution of the substitution
DATE	
RESIDENCE (CITY, STATE and COUNTRY)	Allen, TX, USA
SIGNATURE OF INVENTOR	allthum
PRINTED NAME OF INVENTOR	
ONTE.	12-14, 2014
RESIDENCE (CITY, STATE and COUNTRY)	Doddanskundi, Hangulore, India

Texas instruments incorporated PO Box 655474, M/S 3999 Dallas, TX 75265

PATENT REEL: 032878 FRAME: 0960

RECORDED: 05/13/2014